# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SATOSHI MATSUBARA	06/21/2013
HIDEYUKI UMETSU	06/21/2013
TAKAYUKI HASE	06/21/2013

## RECEIVING PARTY DATA

Name:	TORAY INDUSTRIES, INC.
Street Address:	1-1, NIHONBASHI-MUROMACHI 2-CHOME
Internal Address:	СНИО-КИ
City:	TOKYO
State/Country:	JAPAN
Postal Code:	103-8666

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14009535

## CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	MIP-13-1377 (382460-009)
NAME OF SUBMITTER:	LESLIE J. HOOD
Signature:	/LJH/
Date:	10/03/2013

Total Attachments: 1

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REEL: 031334 FRAME: 0517

### **ASSIGNMENT**

WHEREAS, we, Satoshi MATSUBARA, Hideyuki UMETSU and Takayuki HASE, citizens of Japan, residing at Nagoya-shi, Aichi, Japan, (hereinafter referred to as "the undersigned"), having made an invention entitled LIQUID CRYSTALLINE POLYESTER COMPOSITION AND METAL COMPOSITE MOLDED PRODUCT USING THE SAME, identified in International Application No. PCT/JP2011/006991, and US Application No. 14/009,535 \_\_\_\_\_, (DLA Piper is authorized to insert the Serial No. when known),

WHEREAS, TORAY INDUSTRIES, INC., with offices at 1-1, Nihonbashi-Muromachi 2-chome, Chuo-ku, Tokyo, 103-8666 Japan (hereinafter referred to as "assignee"), is desirous of acquiring the entire right, title and interest in said invention, said US application and all letters patent issuing for said invention,

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and of other good and valuable consideration, receipt of which is hereby acknowledged, the undersigned, intending to be legally bound, does hereby sell, assign and transfer to the assignee the entire right, title and interest, for the United States of America, its territories and possessions, and for all foreign countries, in said invention, including said US application, all divisions and continuations thereof, all rights to claim priority based thereon, all rights to file foreign applications on said invention, and all letters patent and reissues thereof, issuing for said invention in the United States of America and in any and all foreign countries.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the undersigned has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the assignee, and to execute all instruments proper to carry out the intent of this instrument. If the undersigned includes more than one individual, these obligations shall apply to all of the undersigned both individually and collectively.

The rights and property herein conveyed by the undersigned are free and clear of any encumbrance.

EXECUTED on the date(s) set forth below.	
June 21. 20/3	Satoshi Matsubara Satoshi MATSUBARA
Date	Satusiii MATSUBAKA
June 21, 2013 Date	<u> Videyaki Umetsu</u> Hideyuki UMETSU
June 21, 2013 Date	TakayukiHase Takayuki HASE
Date	Takayum HASE
Date	
Date	
Date	

PATENT REEL: 031334 FRAME: 0518

**RECORDED: 10/03/2013**